ΡΛΝ	JIT
	SEMI
	CONDUCTOR

### 30V P-Channel Enhancement Mode MOSFET

Voltage

Current -5 A

#### Features

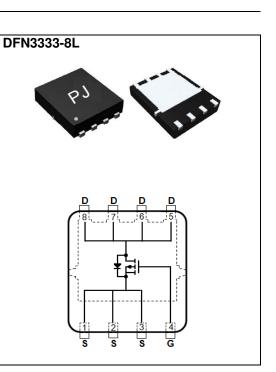
•  $R_{DS(ON)}$ ,  $V_{GS}$ @-10V,  $I_D$ @-3A<50m $\Omega$ 

-30 V

- $R_{DS(ON)}$ ,  $V_{GS}$ @-4.5V,  $I_D$ @-2A<80m $\Omega$
- High switching speed
- Improved dv/dt capability
- Low gate charge
- Low reverse transfer capacitance
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

#### **Mechanical Data**

- Case : DFN3333-8L Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.001 ounces, 0.03 grams



#### **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25<sup>o</sup>C unless otherwise noted)

PARAME	TER	SYMBOL	LIMIT	UNITS
Drain-Source Voltage		V <sub>DS</sub>	-30	
Gate-Source Voltage		V <sub>GS</sub>	<u>+</u> 20	V
Continuous Drain Current	T <sub>A</sub> =25°C	- I <sub>D</sub>	-5.0	
	T <sub>A</sub> =70°C		-4.0	A
Pulsed Drain Current <sup>(Note 1)</sup>		I <sub>DM</sub>	-20	
Power Dissipation	T <sub>A</sub> =25°C	6	2.0	
Power Dissipation	T <sub>A</sub> =70°C	PD	1.3	W
Operating Junction and Storage Temperature Range		T <sub>J</sub> ,T <sub>STG</sub>	-55~150	٥C
Typical Thermal Resistance Junction to Ambient <sup>(Note 5)</sup>		R <sub>θJA</sub>	62.5	°C/W

• Limited only By Maximum Junction Temperature

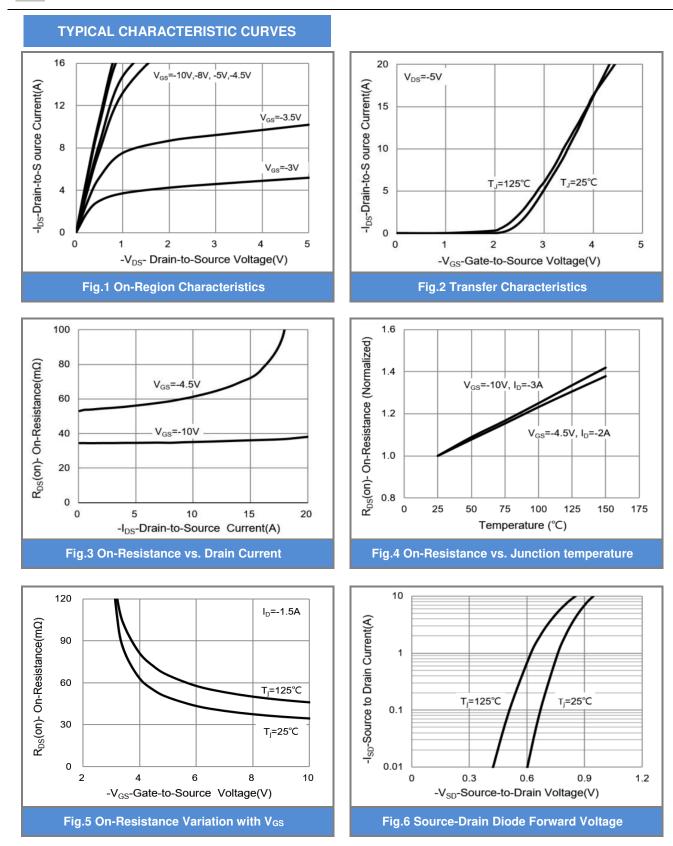


PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA	-30	-	-	
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA	-1	-1.6	-2.5	V
Drain-Source On-State Resistance		$V_{GS}$ =-10V, $I_{D}$ =-3A	-	40	50	mΩ
	R <sub>DS(on)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-2A	-	60	80	
Zero Gate Voltage Drain Current	IDSS	$V_{DS}$ =-30V, $V_{GS}$ =0V	-	-	-1	uA
Gate-Source Leakage Current	lgss	V <sub>GS</sub> = <u>+</u> 20V, V <sub>DS</sub> =0V	-	-	<u>+</u> 100	nA
Dynamic <sup>(Note 6)</sup>						
Total Gate Charge	Qg	V <sub>DS</sub> =-15V, I <sub>D</sub> =-3A, V <sub>GS</sub> =-4.5V <sup>(Note 1,2)</sup>	-	4.8	-	nC
Gate-Source Charge	Qgs		-	1.7	-	
Gate-Drain Charge	Q <sub>gd</sub>		-	1.7	-	
Input Capacitance	Ciss	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1.0MHZ	-	516	-	pF
Output Capacitance	Coss		-	83	-	
Reverse Transfer Capacitance	Crss		-	61	-	
Turn-On Delay Time	td <sub>(on)</sub>	V <sub>DS</sub> =-15V, I <sub>D</sub> =-1A, V <sub>GEN</sub> =-10V, R <sub>G</sub> =6Ω (Note 1.2)	-	5.6	-	
Turn-On Rise Time	tr		-	8.5	-	
Turn-Off Delay Time	td <sub>(off)</sub>		-	27	-	ns
Turn-Off Fall Time	tr		-	18	-	
Drain-Source Diode						
Maximum Continuous Drain-Source Diode Forward Current	Is		-	-	-5	А
Diode Forward Current Diode Forward Voltage	V <sub>SD</sub>	Is=-1A, V <sub>GS</sub> =0V	-	-0.76	-1	V

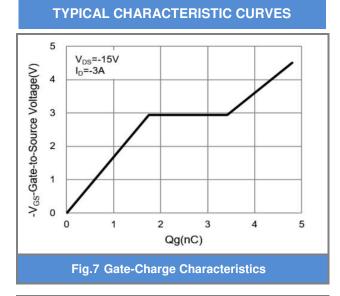
NOTES :

- 1. Pulse width <300us, Duty cycle <2%
- 2. Essentially independent of operating temperature typical characteristics
- 3. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}=150$  °C. Ratings are based on low frequency and duty cycles to keep initial  $T_J = 25$  °C.
- 4. The maximum current rating is package limited
- 5.  $R_{\Theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper
- 6. Guaranteed by design, not subject to production testing.









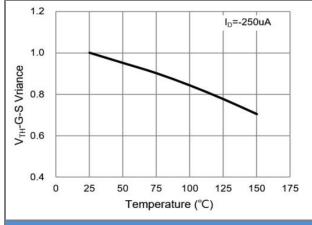
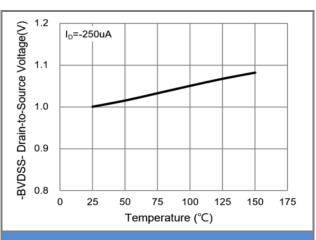


Fig.9 Threshold Voltage Variation with Temperature





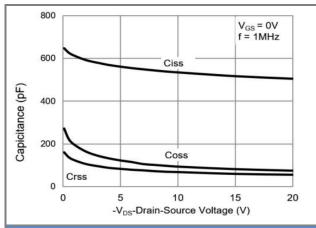


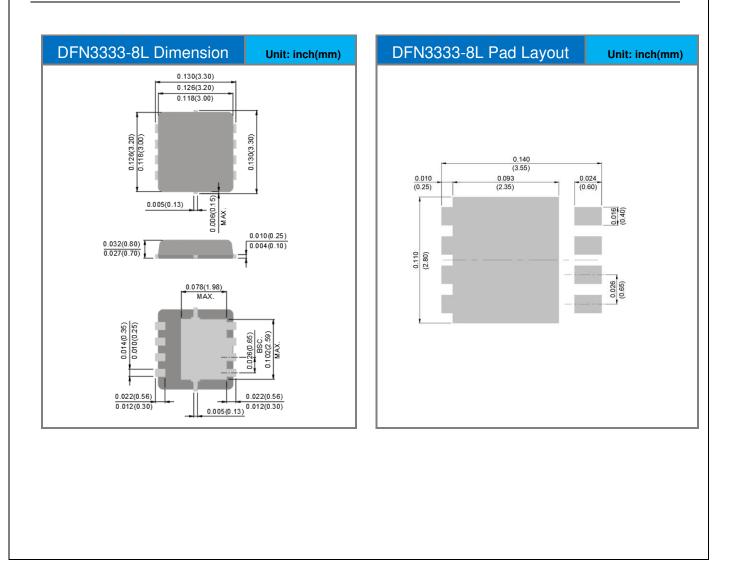
Fig.10 Capacitance vs. Drain-Source Voltage



#### Part No. Packing Code Version

Part No. Packing Code	Package Type	Packing Type	Marking	Version
PJQ4413P_R2_00001	DFN3333-8L	5K pcs / 13" reel	4413	Halogen free RoHS compliant

### **Packaging Information & Mounting Pad Layout**





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